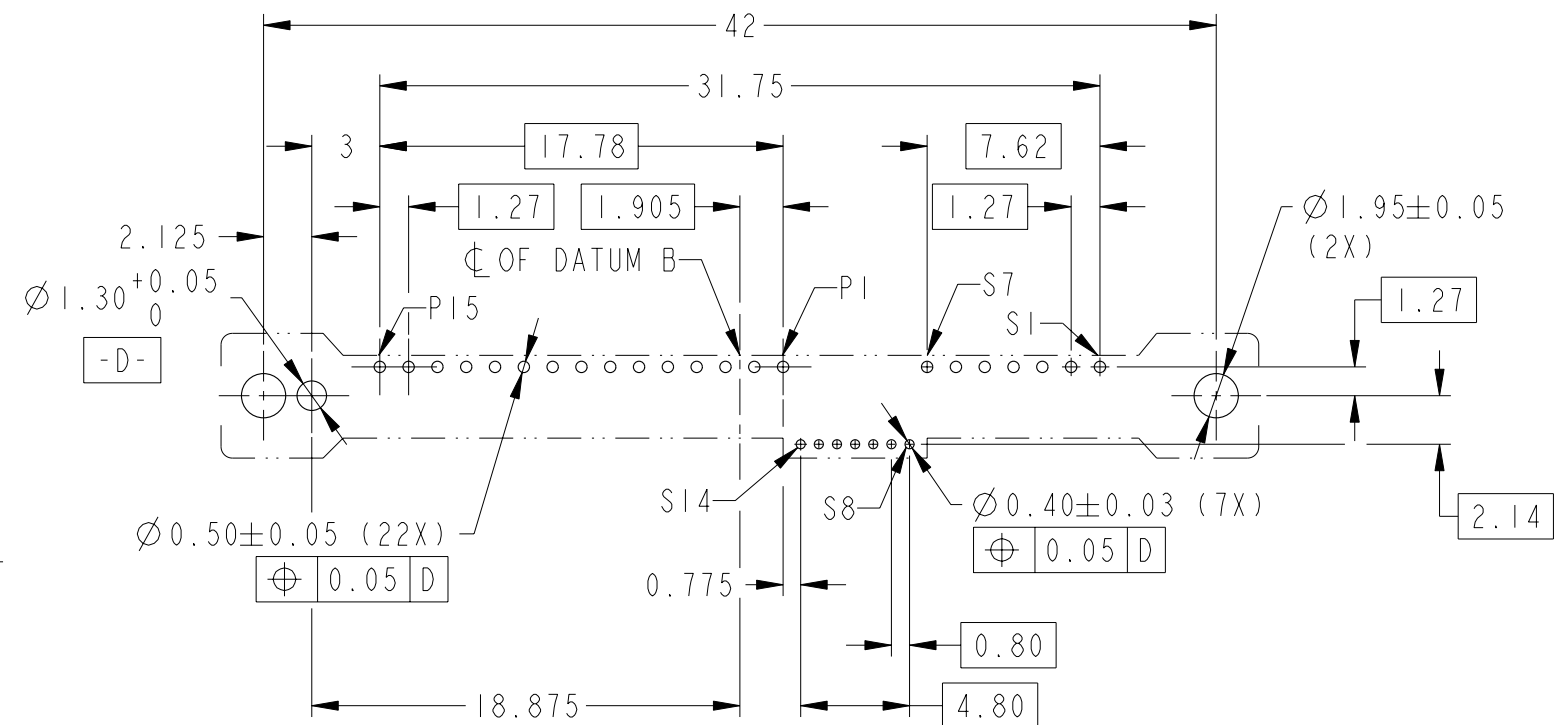
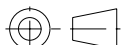


NOTES:

1. MATERIAL :
 1) HOUSING : HIGH TEMP THERMOPLASTIC, UL 94V-0
 COLOR : BLACK
 2) TERMINAL : COPPER ALLOY
 3) HOLD DOWN : COPPER ALLOY
2. FINISH :
 1) TERMINAL : 30μ" Au PLATING (CONTACT POINT) OVER 50μ" NICKEL
 2) SOLDER TAIL : 50μ" MIN Sn OVER 50μ" NICKEL
 3) HOLD DOWN : 50μ" MIN Sn OVER 50μ" NICKEL
3. PER SFF REV 1.1 EXCEPT 0.8mm PITCH BUMP AREA.
4. THE STD PACKAGING IS IN TRAY.
5. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57mm MINIMUM THICK CIRCUIT BOARD.
6. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
7. PART NUMBERS ENDING IN "LF" MEANS FOR NOTE 6 LEAD FREE IDENTIFICATION.
~~P/N XXXXXXXX-XXXLF IS EQUIVALENT TO PREVIOUS P/N XXXXXXXX-XXX.~~
8. A  SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.



RECOMMENDED P.C.B LAYOUT

spec ref		-		dr	GL L00	2004-02-27	projection		MM		size	A3	scale	3:1
tolerance std		TOLERANCES UNLESS OTHERWISE SPECIFIED		eng	GL L00	2004-02-27					ecn no	S10-0228		
ISO 406 ISO 1101				chr	GL L00	2010-10-15								
				appr	JOEY NG	2010-10-15	product family		-	rel level		-		
surface	- 	linear	0.X	± -		title	SAS RECEPTACLE			dwg no	10018182		rev	E
			0.XX	±0.20										
			0.XXX	± -										
ISO 1302		angular	0°	±2°	www.fci.com	cat. no.	-	Product - Customer Drw			sheet 2 of 2			